Customer Information Notification | 201701026I

Issue Date: 27-Jan-2017
Effective Date: 28-Jan-2017

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QUALITY

Management Summary

NXP Semiconductors announces the Reference Manual and Datasheet update for MC9S08PA4.

Change Category

[ ] Wafer Fab Process	[ ] Assembly[ ] Product Marking Process	[ ] Test Location	[ ] Design
[ ] Wafer Fab Materials	[ ] Assembly[ ] Mechanical Materials Specification	[ ]Test Process	[ ] Errata
[ ] Wafer Fab Location	[ ] Assembly[ ] Location Packing/Shipping/Labeling	[ ] Test Equipment	[X] Electrical spec./Test coverage

MC9S08PA4 Reference Manual Update to Rev4 and Datasheet Update to Rev5

Information Notification

NXP Semiconductors announces that the MC9S08PA4 Datasheet has been updated to revision 5 and the Reference manual has been updated to revision 4. Added FTM2 module to Reference manual and Datasheet. The revision history included in the updated document provides a detailed description of the changes.

The updated Datasheet and Reference manual of MC9S08PA4 can be found at:
http://www.nxp.com/products/microcontrollers-and-processors/more-processors/8-16-bit-mcus/8-bit-s08/8-bit-5v-eeprom-with-tsi-mcus:S08P?tab=Documentation_Tab

Why do we issue this Information Notification

The Datasheet and the Reference manual for MC9S08PA4 have been updated to provide additional FTM2 feature.

Identification of Affected Products

Product identification does not change

Impact
There is no change to product form, fit, function, or reliability.
Data Sheet Revision
A new datasheet will be issued

Contact and Support
For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:
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Position   Product Engineer
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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.
Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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Changed Orderable Part#	Customer Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
MC9S08PA4VTG	MC9S08PA4VTG	935315162574	MC9S08PA4VTG	"8 BIT,low end Core,4k Fl"	TSSOP16	RFS	BL Microcontrollers
MC9S08PA4VWJ	MC9S08PA4VWJ	935317879574	MC9S08PA4VWJ	"8 BIT,low end Core,4k Fl"	SO20	RFS	BL Microcontrollers